Octal D-type flip-flop; positive edge-trigger; 3-state Rev. 02 — 24 January 2008 Produc

**Product data sheet** 

#### **General description** 1.

The 74AHC574; 74AHCT574 are high-speed Si-gate CMOS devices and are pin compatible with Low Power Schottky TTL (LSTTL). They are specified in compliance with JEDEC standard no. 7A.

The 74AHC574; 74AHCT574 are octal D-type flip-flops featuring separate D-type inputs for each flip-flop and 3-state outputs for bus oriented applications. A clock (CP) and an output enable  $(\overline{OE})$  input are common to all flip-flops.

The 8 flip-flops will store the state of their individual D-inputs that meet the set-up and hold times requirements on the LOW-to-HIGH CP transition.

When  $\overline{OE}$  is LOW the contents of the 8 flip-flops are available at the outputs. When  $\overline{OE}$  is HIGH, the outputs go to the high-impedance OFF-state. Operation of the OE input does not affect the state of the flip-flops.

The 74AHC574; 74AHCT574 is functionally identical to the 74AHC564; 74AHCT564, but has non-inverting outputs. The 74AHC574; 74AHCT574 is functionally identical to the 74AHC374; 74AHCT374, but has a different pinning.

#### **Features** 2.

- Balanced propagation delays
- All inputs have a Schmitt-trigger action
- 3-state non-inverting outputs for bus orientated applications
- 8-bit positive, edge-triggered register
- Independent register and 3-state buffer operation
- Common 3-state output enable input
- For 74AHC574 only: operates with CMOS input levels
- For 74AHCT574 only: operates with TTL input levels
- ESD protection:
  - HBM JESD22-A114E exceeds 2000 V
  - MM JESD22-A115-A exceeds 200 V
  - CDM JESD22-C101C exceeds 1000 V
- Multiple package options
- Specified from -40 °C to +85 °C and from -40 °C to +125 °C

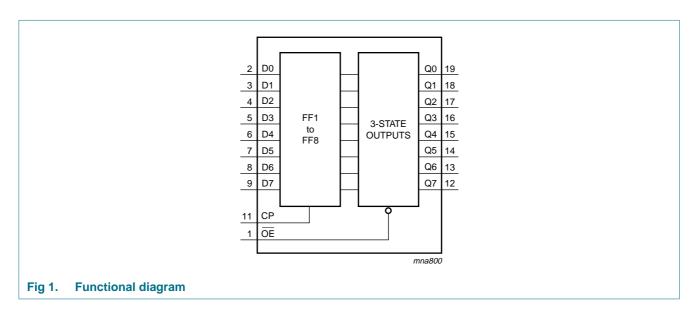
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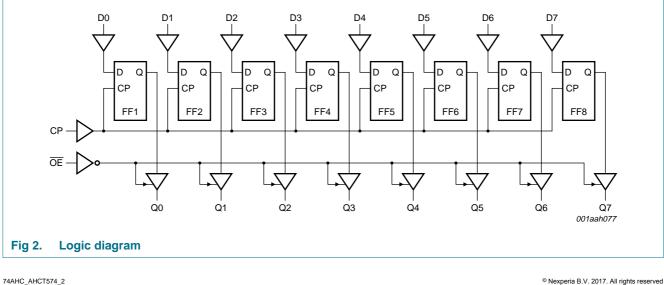
Octal D-type flip-flop; positive edge-trigger; 3-state

### 3. Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
74AHC574D	–40 °C to +125 °C	SO20	plastic small outline package; 20 leads;	SOT163-1
74AHCT574D			body width 7.5 mm	
74AHC574PW	–40 °C to +125 °C	TSSOP20	plastic thin shrink small outline package; 20 leads;	SOT360-1
74AHCT574PW			body width 4.4 mm	
74AHC574BQ	–40 °C to +125 °C	DHVQFN20	plastic dual in-line compatible thermal enhanced	SOT764-1
74AHCT574BQ			very thin quad flat package; no leads; 20 terminals; body $2.5 \times 4.5 \times 0.85$ mm	

### 4. Functional diagram

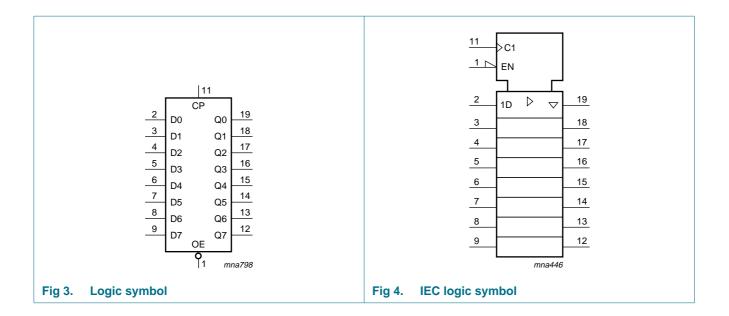




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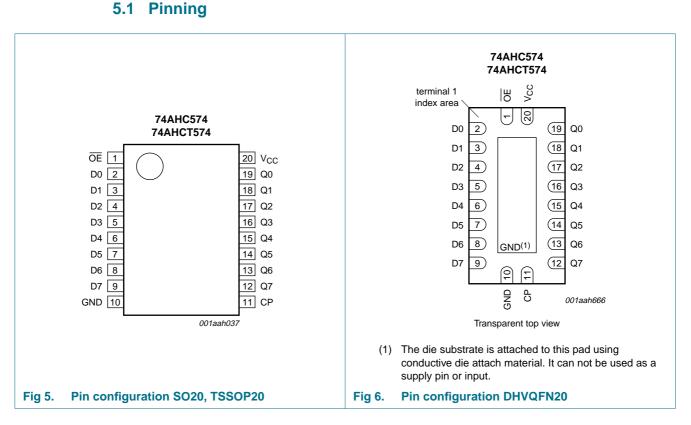
# 74AHC574; 74AHCT574

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Octal D-type flip-flop; positive edge-trigger; 3-state

### 5. Pinning information



### 5.2 Pin description

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Table 2.	Pin description	
Symbol	Pin	Description
ŌĒ	1	3-state output enable input (active LOW)
D[0:7]	2, 3, 4, 5, 6, 7, 8, 9	data input
GND	10	ground (0 V)
СР	11	clock input (LOW-to-HIGH, edge triggered)
Q[0:7]	19, 18, 17, 16, 15, 14, 13, 12	3-state flip-flop output
V <sub>CC</sub>	20	supply voltage

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### 6. Functional description

#### Table 3.Function table

Operating mode	Input			Internal	Output
	OE	СР	Dn	flip-flop	Qn
Load and read register	L	$\uparrow$	I	L	L
	L	$\uparrow$	h	Н	Н
Load register and disable output	Н	$\uparrow$	I	L	Z
	Н	$\uparrow$	h	Н	Z

[1] H = HIGH voltage level;

h = HIGH voltage level one setup time prior to the HIGH-to-LOW CP transition;

L = LOW voltage level;

I = LOW voltage level one setup time prior to the HIGH-to-LOW CP transition;

Z = high-impedance OFF-state;

 $\uparrow$  = LOW-to-HIGH clock transition.

### 7. Limiting values

#### Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		-0.5	+7.0	V
VI	input voltage		-0.5	+7.0	V
l <sub>IK</sub>	input clamping current	V <sub>I</sub> < -0.5 V	[1] -20	-	mA
l <sub>ок</sub>	output clamping current	$V_{\rm O}$ < –0.5 V or $V_{\rm O}$ > $V_{\rm CC}$ + 0.5 V	<u>[1]</u> _	±20	mA
lo	output current	$V_{\rm O}$ = $-0.5$ V to (V_{\rm CC} + 0.5 V)	-	±25	mA
I <sub>CC</sub>	supply current		-	75	mA
I <sub>GND</sub>	ground current		-75	-	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation	$T_{amb} = -40 \ ^{\circ}C$ to +125 $^{\circ}C$			
	SO20 package		[2] _	500	mW
	TSSOP20 package		[3] _	500	mW
	DHVQFN20 package		[4]	500	mW

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2]  $P_{tot}$  derates linearly with 8 mW/K above 70 °C.

[3]  $P_{tot}$  derates linearly with 5.5 mW/K above 60 °C.

[4]  $P_{tot}$  derates linearly with 4.5 mW/K above 60 °C.

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### 8. Recommended operating conditions

#### Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	7	4AHC57	4	7	Unit		
			Min	Тур	Max	Min	Тур	Max	
V <sub>CC</sub>	supply voltage		2.0	5.0	5.5	4.5	5.0	5.5	V
VI	input voltage		0	-	5.5	0	-	5.5	V
Vo	output voltage		0	-	$V_{CC}$	0	-	$V_{CC}$	V
T <sub>amb</sub>	ambient temperature		-40	+25	+125	-40	+25	+125	°C
$\Delta t / \Delta V$	input transition rise	$V_{CC}$ = 3.3 V $\pm$ 0.3 V	-	-	100	-	-	-	ns/V
	and fall rate	$V_{CC}=5.0~V\pm0.5~V$	-	-	20	-	-	20	ns/V

### 9. Static characteristics

#### Table 6. Static characteristics

Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C		<b>−40</b> °C	to +85 °C	–40 °C t	o +125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
For type	74AHC574									
V <sub>IH</sub>	HIGH-level	V <sub>CC</sub> = 2.0 V	1.5	-	-	1.5	-	1.5	-	V
	input voltage	V <sub>CC</sub> = 3.0 V	2.1	-	-	2.1	-	2.1	-	V
		V <sub>CC</sub> = 5.5 V	3.85	-	-	3.85	-	3.85	-	V
VIL	LOW-level	V <sub>CC</sub> = 2.0 V	-	-	0.5	-	0.5	-	0.5	V
	input voltage	V <sub>CC</sub> = 3.0 V	-	-	0.9	-	0.9	-	0.9	V
		V <sub>CC</sub> = 5.5 V	-	-	1.65	-	1.65	-	1.65	V
V <sub>OH</sub>	HIGH-level	$V_{I} = V_{IH} \text{ or } V_{IL}$								
	output voltage	$I_{O} = -50 \ \mu\text{A}; \ V_{CC} = 2.0 \ \text{V}$	1.9	2.0	-	1.9	-	1.9	-	V
		$I_{O} = -50 \ \mu\text{A}; \ V_{CC} = 3.0 \ \text{V}$	2.9	3.0	-	2.9	-	2.9	-	V
		$I_{O} = -50 \ \mu\text{A}; \ V_{CC} = 4.5 \ \text{V}$	4.4	4.5	-	4.4	-	4.4	-	V
		$I_0 = -4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.58	-	-	2.48	-	2.40	-	V
		$I_0 = -8.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.94	-	-	3.8	-	3.70	-	V
V <sub>OL</sub>	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}$								
	output voltage	$I_0 = 50 \ \mu A; \ V_{CC} = 2.0 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_0 = 50 \ \mu A; \ V_{CC} = 3.0 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_{O} = 50 \ \mu\text{A}; \ V_{CC} = 4.5 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_{O}$ = 4.0 mA; $V_{CC}$ = 3.0 V	-	-	0.36	-	0.44	-	0.55	V
		$I_{O}$ = 8.0 mA; $V_{CC}$ = 4.5 V	-	-	0.36	-	0.44	-	0.55	V
I <sub>OZ</sub>	OFF-state output current		-	-	±0.25	-	±2.5	-	±10.0	μΑ
I	input leakage current	V <sub>I</sub> = 5.5 V or GND; V <sub>CC</sub> = 0 V to 5.5 V	-	-	0.1	-	1.0	-	2.0	μA
сс	supply current		-	-	4.0	-	40	-	80	μA
4AHC_AHCT57	74_2							© Nexpe	ria B.V. 2017. All rig	hts reserv

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Octal D-type flip-flop; positive edge-trigger; 3-state

Symbol	Parameter	Conditions		25 °C		–40 °C	to +85 °C	–40 °C t	o +125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
Cı	input capacitance		-	3.0	10	-	10	-	10	pF
Co	output capacitance		-	4.0	-	-	-	-	-	pF
For type	74AHCT574									
V <sub>IH</sub>	HIGH-level input voltage	$V_{CC}$ = 4.5 V to 5.5 V	2.0	-	-	2.0	-	2.0	-	V
V <sub>IL</sub>	LOW-level input voltage	$V_{CC}$ = 4.5 V to 5.5 V	-	-	0.8	-	0.8	-	0.8	V
V <sub>OH</sub>	HIGH-level	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 4.5 \text{ V}$								
	output voltage	I <sub>O</sub> = –50 μA	4.4	4.5	-	4.4	-	4.4	-	V
		I <sub>O</sub> = -8.0 mA	3.94	-	-	3.8	-	3.70	-	V
V <sub>OL</sub>	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 4.5 \text{ V}$								
	output voltage	I <sub>O</sub> = 50 μA	-	0	0.1	-	0.1	-	0.1	V
		I <sub>O</sub> = 8.0 mA	-	-	0.36	-	0.44	-	0.55	V
I <sub>OZ</sub>	OFF-state output current	per input pin; $V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 5.5 V$ ; $I_O = 0 A$ ; $V_O = V_{CC}$ or GND; other pins at $V_{CC}$ or GND	-	-	±0.25	-	±2.5	-	±10.0	μA
lı	input leakage current	$V_I = 5.5 V \text{ or GND};$ $V_{CC} = 0 V \text{ to } 5.5 V$	-	-	0.1	-	1.0	-	2.0	μA
I <sub>CC</sub>	supply current		-	-	4.0	-	40	-	80	μΑ
ΔI <sub>CC</sub>	additional supply current	per input pin; $V_I = V_{CC} - 2.1 \text{ V}; I_O = 0 \text{ A};$ other pins at $V_{CC}$ or GND; $V_{CC} = 4.5 \text{ V}$ to 5.5 V	-	-	1.35	-	1.5	-	1.5	mA
CI	input capacitance		-	3	10	-	10	-	10	pF
Co	output capacitance		-	4.0	-	-	-	-	-	pF

Octal D-type flip-flop; positive edge-trigger; 3-state

### **10. Dynamic characteristics**

#### Table 7. Dynamic characteristics

GND = 0 V. For test circuit see Figure 10.

Symbol	Parameter	Conditions			25 °C		_40 °C	to +85 °C	<b>−40</b> °C t	to +125 °C	Unit
				Min	Typ[1]	Max	Min	Max	Min	Max	
For type	74AHC574										
t <sub>pd</sub>	propagation	CP to Qn; see Figure 7	[2]								
	delay	$V_{CC}$ = 3.0 V to 3.6 V									
		C <sub>L</sub> = 15 pF		-	6.5	13.2	1.0	15.5	1.0	16.5	ns
		$C_L = 50 \text{ pF}$		-	9.3	16.7	1.0	19.0	1.0	21.0	ns
		$V_{CC}$ = 4.5 V to 5.5 V									
		C <sub>L</sub> = 15 pF		-	4.4	8.6	1.0	10.0	1.0	11.0	ns
		$C_L = 50 \text{ pF}$			6.2	10.6	1.0	12.0	1.0	13.5	ns
t <sub>en</sub>	enable time	OE to Qn; see Figure 9	<u>[1]</u>								
		$V_{CC}$ = 3.0 V to 3.6 V									
		C <sub>L</sub> = 15 pF		-	5.7	12.8	1.0	15.0	1.0	16.0	ns
		$C_L = 50 \text{ pF}$		-	8.2	16.3	1.0	18.5	1.0	20.5	ns
		$V_{CC}$ = 4.5 V to 5.5 V									
		C <sub>L</sub> = 15 pF		-	4.2	9.0	1.0	10.5	1.0	11.5	ns
		C <sub>L</sub> = 50 pF		-	5.9	11.0	1.0	12.5	1.0	14.0	ns
t <sub>dis</sub>	disable time	OE to Qn; see Figure 9	[2]								
		$V_{CC}$ = 3.0 V to 3.6 V									
		C <sub>L</sub> = 15 pF		-	6.3	13.0	1.0	15.0	1.0	16.5	ns
		C <sub>L</sub> = 50 pF		-	9.1	15.0	1.0	17.0	1.0	19.0	ns
		$V_{CC}$ = 4.5 V to 5.5 V									
		C <sub>L</sub> = 15 pF		-	4.3	9.0	1.0	10.5	1.0	11.5	ns
		C <sub>L</sub> = 50 pF		-	6.9	10.1	1.0	11.5	1.0	13.0	ns
f <sub>max</sub>	maximum	CP; see Figure 7									
	frequency	$V_{CC}$ = 3.0 V to 3.6 V									
		C <sub>L</sub> = 15 pF		80	125	-	65	-	65	-	MHz
		C <sub>L</sub> = 50 pF		50	75	-	45	-	45	-	MHz
		$V_{CC}$ = 4.5 V to 5.5 V									
		C <sub>L</sub> = 15 pF		130	180	-	110	-	110	-	MHz
		C <sub>L</sub> = 50 pF		85	115	-	75	-	75	-	MHz
t <sub>W</sub>	pulse width	CP; HIGH or LOW; see <u>Figure 7</u>									
		$V_{CC}$ = 3.0 V to 3.6 V; $C_{L}$ = 50 pF		5.0	-	-	5.0	-	5.0	-	ns
		$V_{CC}$ = 4.5 V to 5.5 V; $C_{L}$ = 50 pF		5.0	-	-	5.0	-	5.0	-	ns

Octal D-type flip-flop; positive edge-trigger; 3-state

Symbol	Parameter	Conditions			25 °C		<b>−40 °C</b>	to +85 °C	–40 °C t	o +125 °C	Uni
				Min	Typ[1]	Max	Min	Max	Min	Max	
t <sub>su</sub>	set-up time	Dn to CP; see Figure 8									
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V};$ $C_L = 50 \text{ pF}$		3.5	-	-	3.5	-	3.5	-	ns
		$V_{CC} = 4.5 V \text{ to } 5.5 V;$ $C_L = 50 \text{ pF}$		3.0	-	-	3.0	-	3.0	-	ns
t <sub>h</sub>	hold time	Dn to CP; see Figure 8									
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V};$ $C_{L} = 50 \text{ pF}$		1.5	-	-	1.5	-	1.5	-	ns
		$V_{CC} = 4.5 V \text{ to } 5.5 V;$ $C_{L} = 50 \text{ pF}$		1.5	-	-	1.5	-	1.5	-	ns
C <sub>PD</sub>	power dissipation capacitance	$C_L$ = 50 pF; f <sub>i</sub> = 1 MHz; V <sub>I</sub> = GND to V <sub>CC</sub>	[3]	-	10	-	-	-	-	-	pF
For type	74AHCT574										
t <sub>pd</sub>	propagation	CP to Qn; see Figure 7	[2]								
	delay	$V_{CC}$ = 4.5 V to 5.5 V									
		C <sub>L</sub> = 15 pF		-	4.4	8.6	1.0	10.0	1.0	11.0	ns
		C <sub>L</sub> = 50 pF		-	6.3	10.6	1.0	12.0	1.0	13.5	ns
t <sub>en</sub>	enable time	OE to Qn; see Figure 9									
		$V_{CC}$ = 4.5 V to 5.5 V									
		C <sub>L</sub> = 15 pF		-	4.3	9.0	1.0	10.5	1.0	11.5	ns
		C <sub>L</sub> = 50 pF		-	6.1	11.0	1.0	12.5	1.0	14.0	ns
t <sub>dis</sub>	disable time	OE to Qn; see Figure 9	[2]								
		$V_{CC}$ = 4.5 V to 5.5 V									
		C <sub>L</sub> = 15 pF		-	4.3	9.0	1.0	10.5	1.0	11.5	ns
		C <sub>L</sub> = 50 pF		-	6.2	10.1	1.0	11.5	1.0	13.0	ns
f <sub>max</sub>	maximum	CP; see Figure 7									
	frequency	$V_{CC}$ = 4.5 V to 5.5 V									
		C <sub>L</sub> = 15 pF		130	180	-	110	-	110	-	MH
		C <sub>L</sub> = 50 pF		85	115	-	75	-	75	-	MH
t <sub>W</sub>	pulse width	CP; HIGH or LOW; see <u>Figure 7</u>									
		$V_{CC}$ = 4.5 V to 5.5 V; $C_L$ = 50 pF		5.0	-	-	5.5	-	5.5	-	ns
t <sub>su</sub>	set-up time	Dn to CP; see Figure 8									
		$V_{CC} = 4.5 V$ to 5.5 V; $C_{L} = 50 \text{ pF}$		3.0	-	-	3.5	-	3.5	-	ns

## **Table 7. Dynamic characteristics** ... continued GND = 0 V. For test circuit see Figure 10.

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#### Octal D-type flip-flop; positive edge-trigger; 3-state

Symbol	Parameter	Conditions	25 °C			–40 °C to +85 °C		–40 °C to +125 °C		Unit	
				Min	Typ[1]	Max	Min	Max	Min	Max	
t <sub>h</sub>	hold time	Dn to CP; see Figure 8						•			
		$V_{CC}$ = 4.5 V to 5.5 V; $C_L$ = 50 pF		1.5	-	-	1.5	-	1.5	-	ns
C <sub>PD</sub>	power dissipation capacitance	per buffer; $C_L = 50 \text{ pF}; f = 1 \text{ MHz};$ $V_I = \text{GND to } V_{CC}$	<u>[3]</u>	-	12	-	-	-	-	-	pF

### Table 7. Dynamic characteristics ...continued

[1] Typical values are measured at nominal supply voltage ( $V_{CC}$  = 3.3 V and  $V_{CC}$  = 5.0 V).

 $t_{\text{dis}}$  is the same as  $t_{\text{PLZ}}$  and  $t_{\text{PHZ}}.$ 

- [3]  $C_{PD}$  is used to determine the dynamic power dissipation  $P_D$  ( $\mu W$ ).
  - $P_D = C_{PD} \times V_{CC}^2 \times f_i + \sum (C_L \times V_{CC}^2 \times f_o)$  where:

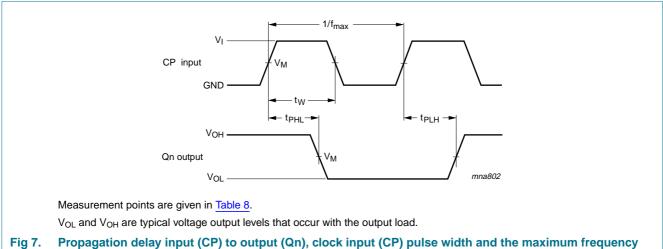
 $f_i$  = input frequency in MHz;

 $f_o = output frequency in MHz;$ 

 $C_L$  = output load capacitance in pF;

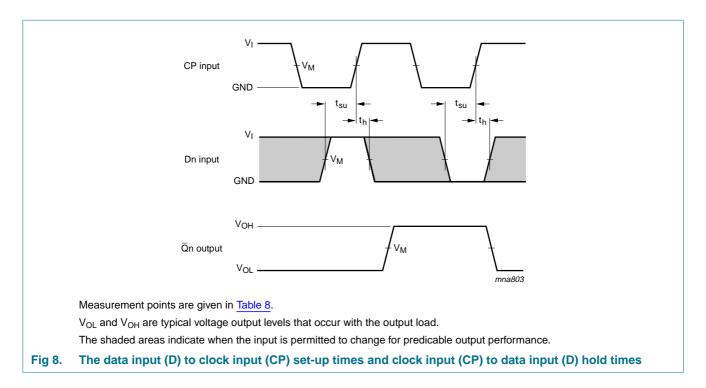
 $V_{CC}$  = supply voltage in V.

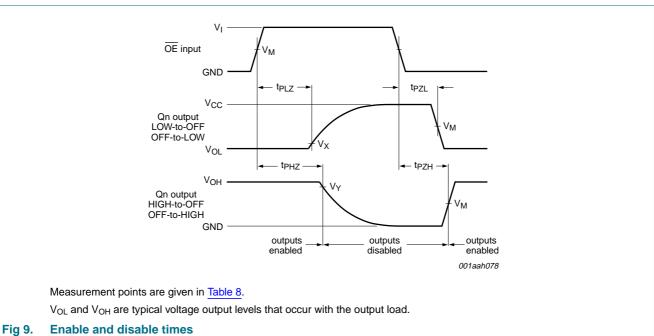
### 10.1 Waveforms



# 74AHC574; 74AHCT574

#### Octal D-type flip-flop; positive edge-trigger; 3-state





#### Table 8. Measurement points

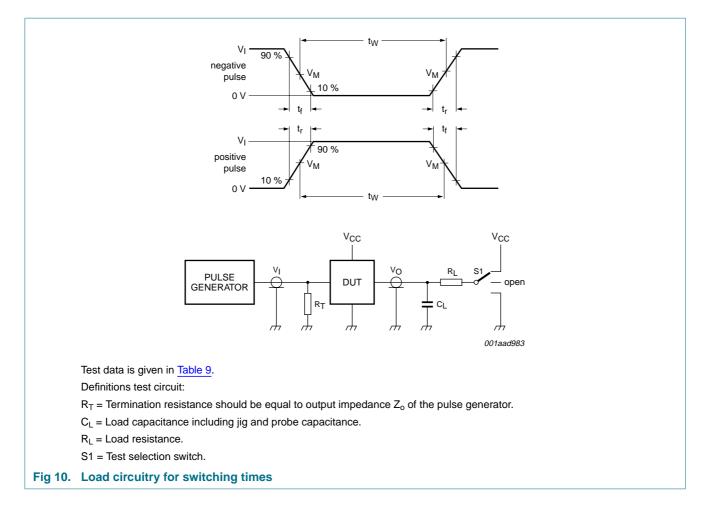
Туре	Input	Output		
	V <sub>M</sub>	V <sub>M</sub>	V <sub>X</sub>	V <sub>Y</sub>
74AHC574	0.5V <sub>CC</sub>	0.5V <sub>CC</sub>	V <sub>OL</sub> + 0.3 V	V <sub>OH</sub> – 0.3 V
74AHCT574	1.5 V	0.5V <sub>CC</sub>	V <sub>OL</sub> + 0.3 V	V <sub>OH</sub> – 0.3 V

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# 74AHC574; 74AHCT574

### Octal D-type flip-flop; positive edge-trigger; 3-state

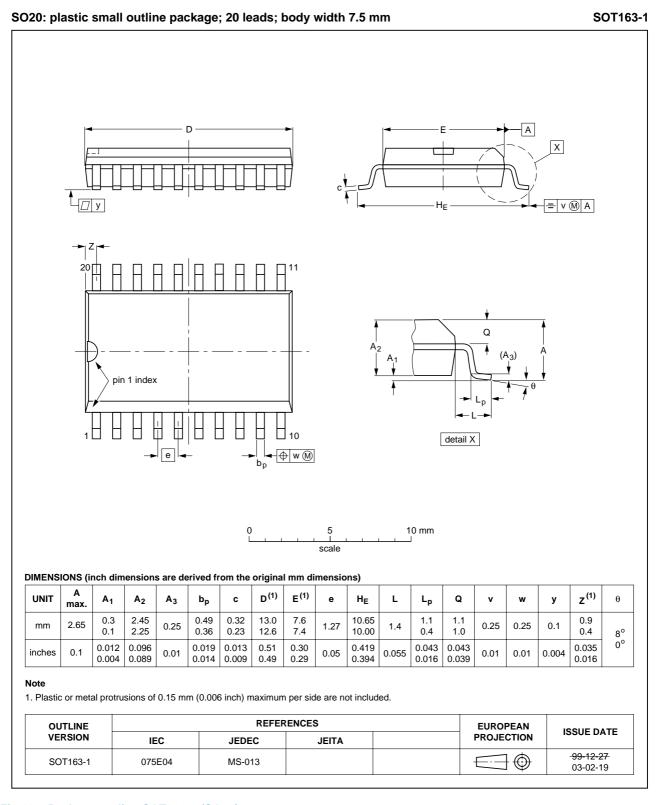


#### Table 9. Test data

Туре	Input Load			S1 position				
	VI	t <sub>r</sub> , t <sub>f</sub>	CL	RL	t <sub>PHL</sub> , t <sub>PLH</sub>	t <sub>PZH</sub> , t <sub>PHZ</sub>	t <sub>PZL</sub> , t <sub>PLZ</sub>	
74AHC574	V <sub>CC</sub>	3.0 ns	15 pF, 50 pF	1 kΩ	open	GND	V <sub>CC</sub>	
74AHCT574	3.0 V	3.0 ns	15 pF, 50 pF	1 kΩ	open	GND	V <sub>CC</sub>	

Octal D-type flip-flop; positive edge-trigger; 3-state

### 11. Package outline

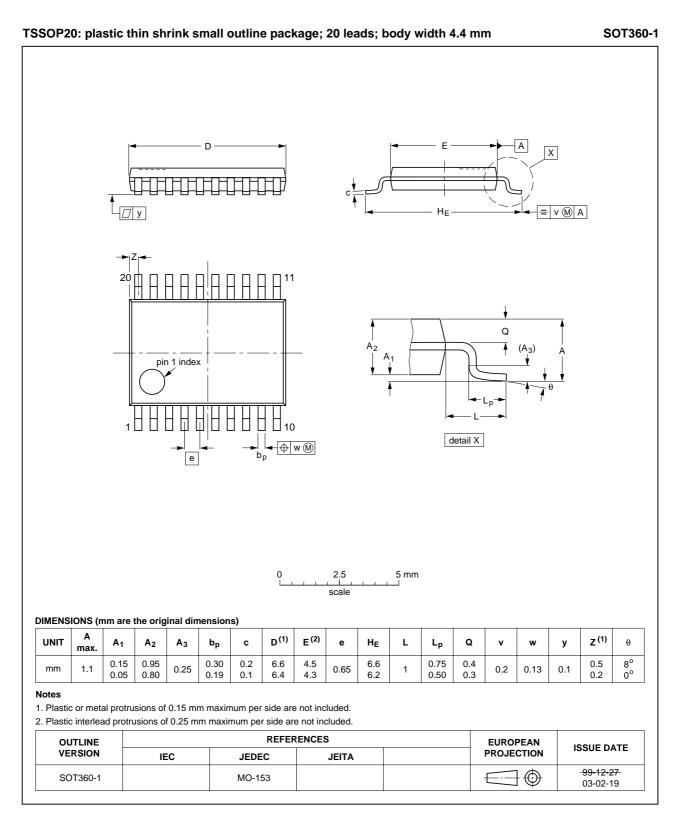


#### Fig 11. Package outline SOT163-1 (SO20)

74AHC\_AHCT574\_2

Product data sheet

Octal D-type flip-flop; positive edge-trigger; 3-state

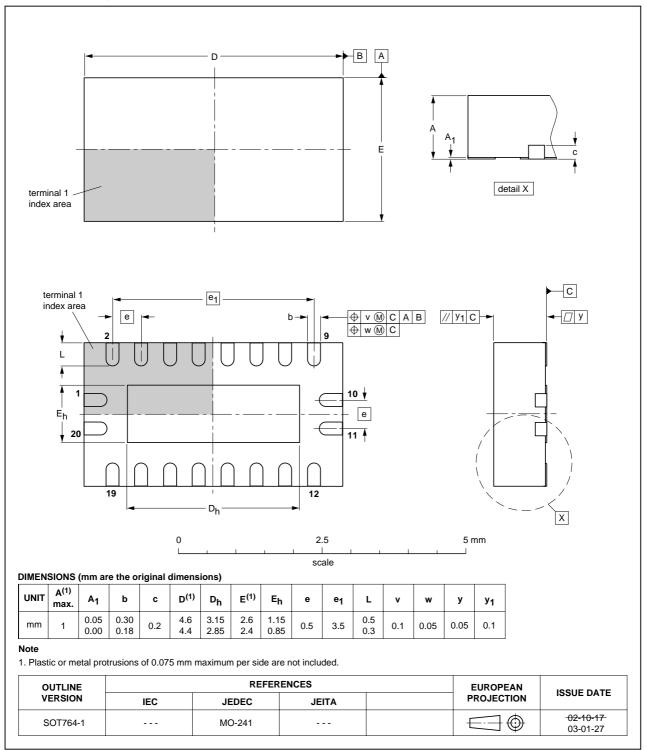


#### Fig 12. Package outline SOT360-1 (TSSOP20)

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Product data sheet

Octal D-type flip-flop; positive edge-trigger; 3-state



#### DHVQFN20: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 20 terminals; body 2.5 x 4.5 x 0.85 mm SOT764-1

Fig 13. Package outline SOT764-1 (DHVQFN20)

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Product data sheet



Octal D-type flip-flop; positive edge-trigger; 3-state

### **12. Abbreviations**

Table 10.	Abbreviations		
Acronym	Description		
CDM	Charged-Device Model		
CMOS	Complementary Metal Oxide Semiconductor		
DUT	Device Under Test		
ESD	ElectroStatic Discharge		
HBM	Human Body Model		
MM	Machine Model		
TTL	Transistor-Transistor Logic		

### 13. Revision history

Table 11. Revision history						
Release date	Data sheet status	Change notice	Supersedes			
20080124	Product data sheet	-	74AHC_AHCT574_1			
<ul> <li>The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors.</li> </ul>						
<ul> <li>Legal texts have been adapted to the new company name where appropriate.</li> </ul>						
<ul> <li><u>Section 3</u>: DH'</li> </ul>	VQFN20 package added.					
<ul> <li><u>Section 7</u>: derating values added for DHVQFN20 package.</li> </ul>						
<ul> <li>Section 11: ou</li> </ul>	Itline drawing added for DF	IVQFN20 package.				
19990616	Product specification	-	-			
	Release date 20080124 • The format of to NXP Semicon • Legal texts hat • Section 3: DH • Section 7: dera • Section 11: out	Release date     Data sheet status       20080124     Product data sheet       • The format of this data sheet has been renned by Semiconductors.       • Legal texts have been adapted to the new       • Section 3: DHVQFN20 package added.       • Section 7: derating values added for DHV       • Section 11: outline drawing added for DHV	Release date       Data sheet status       Change notice         20080124       Product data sheet       -         • The format of this data sheet has been redesigned to comply with NXP Semiconductors.       -         • Legal texts have been adapted to the new company name where       Section 3: DHVQFN20 package added.         • Section 7: derating values added for DHVQFN20 package.       Section 11: outline drawing added for DHVQFN20 package.			

Octal D-type flip-flop; positive edge-trigger; 3-state

### 14. Legal information

### 14.1 Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nexperia.com.

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Octal D-type flip-flop; positive edge-trigger; 3-state

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